

2019 6th International Conference on Mechanical Properties of Materials (ICMPM 2019)

Paris, France
July 23-25, 2019

Submission Deadline: March 10, 2019

Call for Papers

Advanced Characterization Biological Materials
Bulk Crystal Growth Characterization
Computational Materials Science
Corrosion and Environmental Effects
Defects Devices Electrochemistry Electronic Materials
Electronic, Optical, and Magnetic Properties
Magnetic Materials Magnetic Properties Manufacturing
Materials for Energy and Environmental Applications
Materials Processing Nanopatterning Nanotechnology
Optical and Photonic Materials Optoelectronics
More Topics: <http://www.icmpm.org/cfp.html>



Publication

1. Submitted papers will go through a rigorous full peer review process. The accepted papers (registered and presented) of ICMPM 2019 will be published in the conference proceedings, and submitted for Ei Compendex, Scopus index.
2. Some selected papers will be recommended to be published in **International Journal of Materials, Mechanics and Manufacturing** (ISSN: 1793-8198) as a special issue, Abstracting/Indexing: EI (INSPEC, IET), Chemical Abstracts Services (CAS), ProQuest, Crossref, Ulrich's Periodicals Directory, etc.

Conference Chairs

Jan Awrejcewicz, The Lodz University of Technology, Poland
Magnus Thor Jonsson, University of Iceland, Iceland
GIUSEPPE CONTE, Università Politecnica delle Marche, Italy

Submission

1. Please login in Electronic Submission System to submit your abstract or full paper. (<http://confsys.iconf.org/submission/icmpm2019>)
2. You can also submit your abstract or full paper via mailbox icmpm@outlook.com

Contact us

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